V4P22C

Vishay General Semiconductor

# High Current Density Surface-Mount TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.58$  V at  $I_F = 1$  A

## eSMP<sup>®</sup> Series

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### SMPC (TO-277A)

K → Anode 1 Cathode → Anode 2

### **ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 x 2.0 A			
V <sub>RRM</sub>	200 V			
I <sub>FSM</sub>	60 A			
$V_F$ at $I_F = 2 A$	0.65 V			
T <sub>J</sub> max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Common cathode			

### FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters and polarity protection applications.

### **MECHANICAL DATA**

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V4P22C	UNIT	
Device marking code		V422C		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	200	V	
Maximum average forward rectified current per device (fig. 1)	I <sub>F(AV)</sub> <sup>(1)</sup>	4.0	— A	
	I <sub>F(AV)</sub> <sup>(2)</sup>	2.8		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	60	A	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +175	°C	
Storage temperature range	T <sub>STG</sub>	-55 to +175	°C	

#### Notes

<sup>(1)</sup> Mounted on 30 mm x 30 mm pad areas aluminum PCB

<sup>(2)</sup> Free air, mounted on recommended pad area

 $^{(3)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>0JA</sub>

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HALOGEN

FREE

V4P22C



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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25$ °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I <sub>F</sub> = 1 A	T <sub>A</sub> = 25 °C	V <sub>E</sub> (1)	0.74	-	V	
	I <sub>F</sub> = 2 A			0.79	0.87		
	I <sub>F</sub> = 1 A	T <sub>A</sub> = 125 °C		VF ()	V <sub>F</sub> (1) 0.58	-	v
	I <sub>F</sub> = 2 A			0.65	0.73		
Reverse current per diode	$V_{R} = 160 V \qquad \frac{T_{A} = 25 \degree C}{T_{A} = 125 \degree C}$		0.001	-			
		T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	0.3	-	mA	
	V <sub>B</sub> = 200 V	T <sub>A</sub> = 25 °C		-	0.05		
	v <sub>R</sub> = 200 v	T <sub>A</sub> = 125 °C		0.7	3		
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	125	-	pF	

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1  $\,\%$  duty cycle

 $^{(2)}$  Pulse test: pulse width  $\leq 40\ ms$ 

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise specified)					
PARAMETER	SYMBOL	UNIT			
Typical thermal resistance per device	R <sub>0JA</sub> <sup>(1)(2)</sup>	85	°C/W		
	R <sub>0JM</sub> <sup>(3)</sup>	5	0/10		

### Notes

<sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB, thermal resistance R<sub>0JA</sub> - junction-to-ambient

<sup>(3)</sup> Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance  $R_{0,IM}$  - junction-to-mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V4P22C-M3/H	0.10	Н	1500	7" diameter plastic tape and reel		
V4P22C-M3/I	0.10	I	6500	13" diameter plastic tape and reel		
V4P22CHM3/H <sup>(1)</sup>	0.10	Н	1500	7" diameter plastic tape and reel		
V4P22CHM3/I (1)	0.10	I	6500	13" diameter plastic tape and reel		

#### Note

<sup>(1)</sup> AEC-Q101 qualified



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# **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

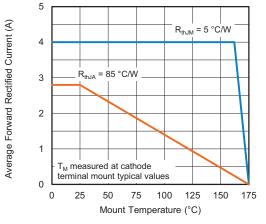


Fig. 1 - Maximum Forward Current Derating Curve

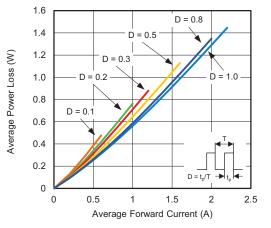


Fig. 2 - Forward Power Loss Characteristics Per Diode

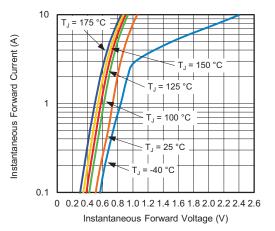


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

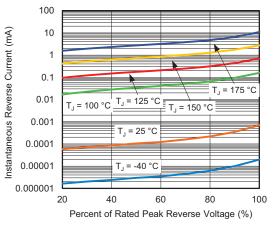


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

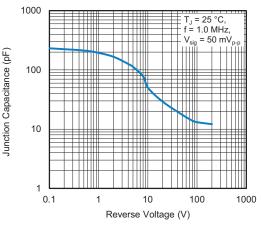
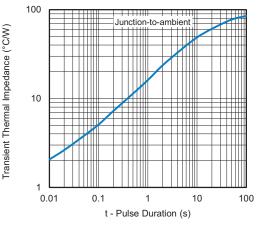


Fig. 5 - Typical Junction Capacitance Per Diode





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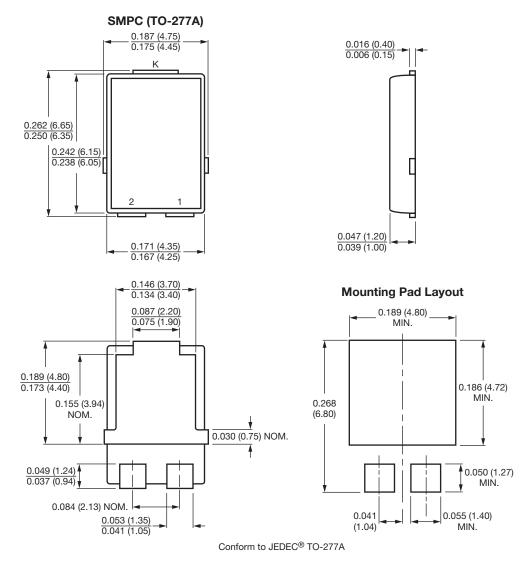
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## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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